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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	RL78
Core Size	16-Bit
Speed	32MHz
Connectivity	CSI, I ² C, LINbus, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	21
Program Memory Size	48KB (48K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	5.5K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	30-LSSOP (0.240", 6.10mm Width)
Supplier Device Package	30-LSSOP
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f104adasp-v0

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

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Pin count	Package	Fields of Application Note	Ordering Part Number
40 pins	40-pin plastic HWQFN (6 × 6 mm, 0.5 mm pitch)	A	R5F104EAANA#U0, R5F104ECANA#U0, R5F104EDANA#U0, R5F104EEANA#U0, R5F104EFANA#U0, R5F104EGANA#U0, R5F104EHANA#U0
			R5F104EAANA#W0, R5F104ECANA#W0, R5F104EDANA#W0, R5F104EEANA#W0, R5F104EEANA#W0, R5F104EFANA#W0, R5F104EHANA#W0
		D	R5F104EADNA#U0, R5F104ECDNA#U0, R5F104EDDNA#U0, R5F104EEDNA#U0, R5F104EEDNA#U0, R5F104EFDNA#U0, R5F104EFDNA#U0
			R5F104EADNA#W0, R5F104ECDNA#W0, R5F104EDDNA#W0, R5F104EEDNA#W0, R5F104EEDNA#W0, R5F104EFDNA#W0, R5F104EHDNA#W0
		G	R5F104EAGNA#U0, R5F104ECGNA#U0, R5F104EDGNA#U0, R5F104EEGNA#U0, R5F104EEGNA#U0, R5F104EFGNA#U0, R5F104EGGNA#U0, R5F104EHGNA#U0
			R5F104EAGNA#W0, R5F104ECGNA#W0, R5F104EDGNA#W0, R5F104EEGNA#W0, R5F104EFGNA#W0, R5F104EGGNA#W0, R5F104EHGNA#W0
44 pins	44-pin plastic LQFP $(10 \times 10, 0.8 \text{ mm pitch})$	A	R5F104FAAFP#V0, R5F104FCAFP#V0, R5F104FDAFP#V0, R5F104FEAFP#V0, R5F104FFAFP#V0, R5F104FGAFP#V0, R5F104FHAFP#V0, R5F104FJAFP#V0
			R5F104FAAFP#X0, R5F104FCAFP#X0, R5F104FDAFP#X0, R5F104FEAFP#X0, R5F104FFAFP#X0, R5F104FGAFP#X0, R5F104FHAFP#X0, R5F104FJAFP#X0
		D	R5F104FADFP#V0, R5F104FCDFP#V0, R5F104FDDFP#V0, R5F104FEDFP#V0, R5F104FFDFP#V0, R5F104FGDFP#V0, R5F104FHDFP#V0, R5F104FJDFP#V0
			R5F104FADFP#X0, R5F104FCDFP#X0, R5F104FDDFP#X0, R5F104FEDFP#X0, R5F104FFDFP#X0, R5F104FGDFP#X0, R5F104FHDFP#X0, R5F104FJDFP#X0
		G	R5F104FAGFP#V0, R5F104FCGFP#V0, R5F104FDGFP#V0, R5F104FEGFP#V0, R5F104FFGFP#V0, R5F104FGGFP#V0, R5F104FHGFP#V0, R5F104FJGFP#V0
			R5F104FAGFP#X0, R5F104FCGFP#X0, R5F104FDGFP#X0, R5F104FEGFP#X0, R5F104FFGFP#X0, R5F104FGGFP#X0, R5F104FHGFP#X0, R5F104FJGFP#X0

Note For the fields of application, refer to Figure 1 - 1 Part Number, Memory Size, and Package of RL78/G14.

Caution The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.



(R20UT2944).

 Note
 The flash library uses RAM in self-programming and rewriting of the data flash memory.

 The target products and start address of the RAM areas used by the flash library are shown below.

 R5F104xL (x = G, L, M, P): Start address F3F00H

 For the RAM areas used by the flash library, see Self RAM list of Flash Self-Programming Library for RL78 Family



2.3 DC Characteristics

2.3.1 Pin characteristics

(TA = -40 to +85°C, 1.6 V \leq EVDD0 = EVDD1 \leq VDD \leq 5.5 V, VSS = EVSS0 = EVSS1 = 0 V)

Items	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Output current, high Note 1	Іон1	Per pin for P00 to P06, P10 to P17, P30, P31, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100 to P102, P110, P111, P120, P130, P140 to P147	$1.6 \text{ V} \leq \text{EVDD0} \leq 5.5 \text{ V}$			-10.0 Note 2	mA
		Total of P00 to P04, P40 to P47,	$4.0~V \leq EV_{DD0} \leq 5.5~V$			-55.0	mA
		P102, P120, P130, P140 to P145	$2.7 \text{ V} \leq \text{EV}_{\text{DD0}} < 4.0 \text{ V}$			-10.0	mA
		(When duty $\leq 70\%$ Note 3)	$1.8 \text{ V} \leq \text{EV}_{\text{DD0}} < 2.7 \text{ V}$			-5.0	mA
			$1.6 \text{ V} \le \text{EV}_{\text{DD0}} < 1.8 \text{ V}$			-2.5	mA
		Total of P05, P06, P10 to P17, P30, P31, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100, P101, P110, P111, P146, P147 (When duty ≤ 70% ^{Note 3})	$4.0~V \leq EV_{DD0} \leq 5.5~V$			-80.0	mA
			$2.7 \text{ V} \le \text{EV}_{\text{DD0}} \le 4.0 \text{ V}$			-19.0	mA
			$1.8 \text{ V} \le \text{EV}_{\text{DD0}} < 2.7 \text{ V}$			-10.0	mA
			$1.6 \text{ V} \le \text{EV}_{\text{DD0}} < 1.8 \text{ V}$			-5.0	mA
		Total of all pins (When duty \leq 70% ^{Note 3})	$1.6 \text{ V} \le \text{EVDD0} \le 5.5 \text{ V}$			-135.0 Note 4	mA
	Іон2	Per pin for P20 to P27, P150 to P156	$1.6 \text{ V} \leq \text{VDD} \leq 5.5 \text{ V}$			-0.1 Note 2	mA
		Total of all pins (When duty \leq 70% ^{Note 3})	$1.6 \text{ V} \le \text{VDD} \le 5.5 \text{ V}$			-1.5	mA

Note 1. Value of current at which the device operation is guaranteed even if the current flows from the EVDD0, EVDD1, VDD pins to an output pin.

Note 2. Do not exceed the total current value.

Note 3. Specification under conditions where the duty factor ≤ 70%. The output current value that has changed to the duty factor > 70% the duty ratio can be calculated with the following expression (when changing the duty factor from 70% to n%).

• Total output current of pins = $(IOH \times 0.7)/(n \times 0.01)$ <Example> Where n = 80% and IOH = -10.0 mA Total output current of pins = $(-10.0 \times 0.7)/(80 \times 0.01) \approx -8.7$ mA

However, the current that is allowed to flow into one pin does not vary depending on the duty factor. A current higher than the absolute maximum rating must not flow into one pin.

Note 4. -100 mA for industrial applications (R5F104xxDxx, R5F104xxGxx).

Caution P00, P02 to P04, P10, P11, P13 to P15, P17, P30, P43 to P45, P50 to P55, P71, P74, P80 to P82, and P142 to P144 do not output high level in N-ch open-drain mode.



Remark Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

- Note 1. Total current flowing into VDD, EVDDD, and EVDD1, including the input leakage current flowing when the level of the input pin is fixed to VDD, EVDDD, and EVDD1, or Vss, EVss0, and EVss1. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, D/A converter, comparator, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
 Note 2. When high-speed on-chip oscillator and subsystem clock are stopped.
- Note 3. When high-speed system clock and subsystem clock are stopped.
- **Note 4.** When high-speed on-chip oscillator and high-speed system clock are stopped. When AMPHS1 = 1 (Ultra-low power consumption oscillation). However, not including the current flowing into the 12-bit interval timer and watchdog timer.
- Note 5. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.

HS (high-speed main) mode: $2.7 \text{ V} \le \text{V}_{\text{DD}} \le 5.5 \text{ V}_{\text{@1}} \text{ MHz to } 32 \text{ MHz}$

2.4 V \leq VDD \leq 5.5 V@1 MHz to 16 MHz

LS (low-speed main) mode: $$1.8~V \le V \mbox{DD} \le 5.5~V \ensuremath{\textcircled{0}}1~\mbox{MHz}$ to 8 MHz}$$

LV (low-voltage main) mode: $1.6 \text{ V} \le \text{V}_{DD} \le 5.5 \text{ V}_{@}1 \text{ MHz}$ to 4 MHz

- Remark 1. fmx: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
- Remark 2. fHoco: High-speed on-chip oscillator clock frequency (64 MHz max.)
- **Remark 3.** fin: High-speed on-chip oscillator clock frequency (32 MHz max.)
- Remark 4. fsub: Subsystem clock frequency (XT1 clock oscillation frequency)
- Remark 5. Except subsystem clock operation, temperature condition of the TYP. value is TA = 25°C







(2) During communication at same potential (CSI mode) (master mode, SCKp... internal clock output, corresponding CSI00 only)

Parameter	Symbol	Conditions		HS (high-s main) mo	peed ode	LS (low-s) main) me	peed ode	LV (low-vo main) me	ltage ode	Unit
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCKp cycle time	tkcy1	tkcy1 ≥ 2/fclk	$4.0~V \leq EV_{DD0} \leq 5.5~V$	62.5		250		500		ns
			$2.7~V \leq EV_{DD0} \leq 5.5~V$	83.3		250		500		ns
SCKp high-/low-level	tкнı,	$4.0 \; V \leq EV_{\text{DD0}}$	≤ 5.5 V	tксү1/2 - 7		tксү1/2 - 50		tксү1/2 - 50		ns
width	tĸ∟1	$2.7 \text{ V} \leq \text{EV}_{\text{DD0}} \leq 5.5 \text{ V}$		tксү1/2 - 10		tксү1/2 - 50		tксү1/2 - 50		ns
SIp setup time (to SCKp \uparrow)	tsik1	$4.0 \; V \leq EV_{\text{DD0}}$	≤ 5.5 V	23		110		110		ns
Note 1		$2.7 \; V \leq EV_{\text{DD0}}$	≤ 5.5 V	33		110		110		ns
SIp hold time (from SCKp↑) ^{Note 2}	tksi1	$2.7 \text{ V} \leq EV_{\text{DD0}}$	≤ 5.5 V	10		10		10		ns
Delay time from SCKp↓ to SOp output ^{Note 3}	tkso1	C = 20 pF Note	4		10		10		10	ns

(TA = -40 to +85°C, 2.7 V \leq EVDD0 = EVDD1 \leq VDD \leq 5.5 V, VSS = EVSS0 = EVSS1 = 0 V)

Note 2. When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The Slp hold time becomes "from SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

Note 3. When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The delay time to SOp output becomes "from SCKp↑" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

Note 4. C is the load capacitance of the SCKp and SOp output lines.

Caution Select the normal input buffer for the SIp pin and the normal output mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg).

Remark 1. This value is valid only when CSI00's peripheral I/O redirect function is not used.

Remark 2. p: CSI number (p = 00), m: Unit number (m = 0), n: Channel number (n = 0),

g: PIM and POM numbers (g = 1)

Remark 3. fMCK: Serial array unit operation clock frequency (Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00))



Note 1. When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The SIp setup time becomes "to SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

Parameter	Symbol		Conditions	HS (high-s main) mo	peed ode	LS (low-speed mode	d main)	LV (low-vo main) mo	ltage ode	Unit
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCKp cycle time	tkCY1	tксү1 ≥ 4/fcLк	$2.7~V \leq E_{VDD0} \leq 5.5~V$	125		500		1000		ns
			$2.4~\text{V} \leq \text{EV}_{\text{DD0}} \leq 5.5~\text{V}$	250		500		1000		ns
			$1.8~V \leq EV_{DD0} \leq 5.5~V$	500		500		1000		ns
			$1.7 \text{ V} \leq \text{EV}_{\text{DD0}} \leq 5.5 \text{ V}$	1000		1000		1000		ns
			$1.6 \text{ V} \le \text{EV}_{\text{DD0}} \le 5.5 \text{ V}$	—		1000		1000		ns
SCKp high-/low-level	tĸнı,	$4.0 \text{ V} \leq \text{EV}_{\text{DDO}}$	0 ≤ 5.5 V	tксү1/2 - 12		tксү1/2 - 50		tксү1/2 - 50		ns
width	tKL1	$2.7 \text{ V} \leq \text{EV}_{\text{DDO}}$	$\leq 5.5 V$	tксү1/2 - 18		tксү1/2 - 50		tксү1/2 - 50		ns
		$2.4 \text{ V} \leq \text{EV}_{\text{DDO}}$	$0 \leq 5.5 \text{ V}$	tксү1/2 - 38		tксү1/2 - 50		tксү1/2 - 50		ns
		$1.8 \text{ V} \leq \text{EV}_{\text{DDO}}$	$\leq 5.5 V$	tксү1/2 - 50		tксү1/2 - 50		tксү1/2 - 50		ns
		$1.7 \text{ V} \leq \text{EV}_{\text{DDO}}$	$\leq 5.5 V$	tксү1/2 - 100		tксү1/2 - 100		tксү1/2 - 100		ns
		$1.6 \text{ V} \leq \text{EV}_{\text{DDO}}$	$\leq 5.5 V$	—		tксү1/2 - 100		tксү1/2 - 100		ns
SIp setup time	tsik1	$4.0 \text{ V} \leq \text{EV}_{\text{DDO}}$	$\leq 5.5 V$	44		110		110		ns
(to SCKp↑) ^{Note 1}		$2.7 \text{ V} \leq \text{EV}_{\text{DDO}}$	$\leq 5.5 V$	44		110		110		ns
		$2.4 \text{ V} \leq \text{EV}_{\text{DDO}}$	$\leq 5.5 V$	75		110		110		ns
		$1.8 \text{ V} \leq \text{EV}_{\text{DDO}}$	$\leq 5.5 V$	110		110		110		ns
		$1.7 \text{ V} \leq \text{EV}_{\text{DDO}}$	$\leq 5.5 V$	220		220		220		ns
		$1.6 \text{ V} \leq \text{EV}_{\text{DDO}}$	$\leq 5.5 V$	—		220		220		ns
SIp hold time	tksi1	$1.7 \text{ V} \leq \text{EV}_{\text{DDC}}$	$\leq 5.5 V$	19		19		19		ns
(from SCKp↑) Note 2		$1.6 \text{ V} \leq \text{EV}_{\text{DDO}}$	$\leq 5.5 V$	—		19		19		ns
Delay time from SCKp↓ to SOp output	tkso1	$1.7 V \le EV_{DDC}$ C = 30 pF Note	o ≤ 5.5 V e 4		25		25		25	ns
		$1.6 V \le EV_{DDC}$ C = 30 pF Note	o ≤ 5.5 V e 4		_		25		25	ns

(3) During communication at same potential (CSI mode) (master mode, SCKp... internal clock output) (TA = -40 to +85°C, 1.6 V \leq EVDD0 = EVDD1 \leq VDD \leq 5.5 V, Vss = EVss0 = EVss1 = 0 V)

Note 1. When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The SIp setup time becomes "to SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

Note 2. When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The Slp hold time becomes "from SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

Note 3. When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The delay time to SOp output becomes "from SCKp↑" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

Note 4. C is the load capacitance of the SCKp and SOp output lines.

Caution Select the normal input buffer for the SIp pin and the normal output mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg).

Remark 1. p: CSI number (p = 00, 01, 10, 11, 20, 21, 30, 31), m: Unit number (m = 0, 1), n: Channel number (n = 0 to 3), g: PIM number (g = 0, 1, 3 to 5, 14)

Remark 2. fmck: Serial array unit operation clock frequency (Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))



(6) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode)

(TA = -40 to +85°C, 1.6 V \leq EVDD0 = EVDD1 \leq VDD \leq 5.5 V, Vss = EVss0 = EVss1 = 0 V)

(2/2)

Parameter	Symbol	Conditions		HS (high r	HS (high-speed main) mode		LS (low-speed main) mode		LV (low-voltage main) mode	
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Transfer rate		transmission	$\begin{array}{l} 4.0 \; V \leq EV_{DD0} \leq 5.5 \; V, \\ 2.7 \; V \leq V_b \leq 4.0 \; V \end{array}$		Note 1		Note 1		Note 1	bps
			$\label{eq:constraint} \begin{array}{l} Theoretical value of the \\ maximum transfer rate \\ C_b = 50 \mbox{ pF}, \mbox{ R}_b = 1.4 \mbox{ k}\Omega, \\ V_b = 2.7 \mbox{ V} \end{array}$		2.8 Note 2		2.8 Note 2		2.8 Note 2	Mbps
			$2.7 \text{ V} \le \text{EV}_{\text{DD0}} < 4.0 \text{ V},$ $2.3 \text{ V} \le \text{V}_{\text{b}} \le 2.7 \text{ V}$		Note 3		Note 3		Note 3	bps
		$\label{eq:constraint} \begin{array}{l} Theoretical value of the \\ maximum transfer rate \\ C_b = 50 \mbox{ pF}, \mbox{ R}_b = 2.7 \mbox{ k}\Omega, \\ V_b = 2.3 \mbox{ V} \end{array}$		1.2 Note 4		1.2 Note 4		1.2 Note 4	Mbps	
			$\begin{array}{l} 1.8 \ V \leq EV_{DD0} < 3.3 \ V, \\ 1.6 \ V \leq V_b \leq 2.0 \ V \end{array}$		Notes 5, 6		Notes 5, 6		Notes 5, 6	bps
			Theoretical value of the maximum transfer rate $C_b = 50 \text{ pF}, R_b = 5.5 \text{ k}\Omega, V_b = 1.6 \text{ V}$		0.43 Note 7		0.43 Note 7		0.43 Note 7	Mbps

Note 1. The smaller maximum transfer rate derived by using fMCK/6 or the following expression is the valid maximum transfer rate. Expression for calculating the transfer rate when $4.0 \text{ V} \le \text{EV}\text{DD0} \le 5.5 \text{ V}$ and $2.7 \text{ V} \le \text{Vb} \le 4.0 \text{ V}$

1

Maximum transfer rate =
$$\frac{1}{\{-C_b \times R_b \times \ln (1 - \frac{2.2}{V_b})\} \times 3}$$
 [bps]

Baud rate error (theoretical value) =
$$\frac{\frac{1}{|\text{Transfer rate} \times 2|} - \{-C_b \times R_b \times \ln(1 - \frac{2.2}{|V_b|})\}}{(\frac{1}{|\text{Transfer rate}|}) \times \text{Number of transferred bits}}$$

* This value is the theoretical value of the relative difference between the transmission and reception sides

Note 2.This value as an example is calculated when the conditions described in the "Conditions" column are met.Refer to Note 1 above to calculate the maximum transfer rate under conditions of the customer.

Note 3. The smaller maximum transfer rate derived by using fMCK/6 or the following expression is the valid maximum transfer rate.

Expression for calculating the transfer rate when 2.7 V \leq EVDD0 < 4.0 V and 2.3 V \leq Vb \leq 2.7 V

Maximum transfer rate =
$$\frac{1}{\{-C_b \times R_b \times \ln (1 - \frac{2.0}{V_b})\} \times 3}$$
Baud rate error (theoretical value) =
$$\frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln (1 - \frac{2.0}{V_b})\}}{(\frac{1}{\text{Transfer rate}}) \times \text{Number of transferred bits}}$$

* This value is the theoretical value of the relative difference between the transmission and reception sides



(8) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (master mode, SCKp... internal clock output)

Parameter	Symbol		Conditions	HS (high-s main) mo	peed ode	LS (low-speed mode	d main)	LV (low-vol main) mo	ltage ode	Unit
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCKp cycle time	tксү1	tkcy1 ≥ 4/fclk		300		1150		1150		ns
			$\begin{array}{l} 2.7 \ V \leq EV_{DD0} < 4.0 \ V, \\ 2.3 \ V \leq V_b \leq 2.7 \ V, \\ C_b = 30 \ pF, \ R_b = 2.7 \ k\Omega \end{array}$	500		1150		1150		ns
			1150		1150		1150		ns	
SCKp high-level width	tкнı	$\begin{array}{l} 4.0 \ V \leq EV_{DD0} \\ 2.7 \ V \leq V_b \leq 4. \\ C_b = 30 \ pF, \ R_b \end{array}$	≤ 5.5 V, 0 V, = 1.4 kΩ	tксү1/2 - 75		tксү1/2 - 75		tксү1/2 - 75		ns
		$\begin{split} & 2.7 \ V \leq EV_{DD0} < 4.0 \ V, \\ & 2.3 \ V \leq V_b \leq 2.7 \ V, \\ & C_b = 30 \ pF, \ R_b = 2.7 \ k\Omega \\ & 1.8 \ V \leq EV_{DD0} < 3.3 \ V, \\ & 1.6 \ V \leq V_b \leq 2.0 \ V \ ^{Note}, \\ & C_b = 30 \ pF, \ R_b = 5.5 \ k\Omega \end{split}$		tксү1/2 - 170		tксү1/2 - 170		tксү1/2 - 170		ns
				tксү1/2 - 458		tксү1/2 - 458		tkcy1/2 - 458		ns
SCKp low-level width	tĸL1	$\begin{array}{l} 4.0 \ V \leq EV_{DD0} \\ 2.7 \ V \leq V_b \leq 4. \\ C_b = 30 \ pF, \ R_b \end{array}$	≤ 5.5 V, 0 V, = 1.4 kΩ	tксү1/2 - 12		tксү1/2 - 50		tксү1/2 - 50		ns
		$\begin{array}{l} 2.7 \ V \leq EV_{DD0} \\ 2.3 \ V \leq V_{b} \leq 2. \\ C_{b} = 30 \ pF, \ R_{b} \end{array}$	< 4.0 V, 7 V, = 2.7 kΩ	tксү1/2 - 18		tксү1/2 - 50		tkcy1/2 - 50		ns
		$1.8 V \le EV_{DD0}$ $1.6 V \le V_b \le 2.$ $C_b = 30 \text{ pF, Rb}$	< 3.3 V, 0 V ^{Note} , = 5.5 kΩ	tксү1/2 - 50		tксү1/2 - 50		tксү1/2 - 50		ns

(TA = -40 to +85°C, 1.8 V \leq EVDD0 = EVDD1 \leq VDD \leq 5.5 V, VSS = EVSS0 = EVSS1 = 0 V)

Note Use it with $EVDD0 \ge Vb$.

(Remarks are listed two pages after the next page.)



Caution Select the TTL input buffer for the SIp pin and the N-ch open drain output (VDD tolerance (for the 30- to 52-pin products)/EVDD tolerance (for the 64- to 100-pin products)) mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg). For VIH and VIL, see the DC characteristics with TTL input buffer selected.



CSI mode serial transfer timing (master mode) (during communication at different potential) (When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.)





- Remark 1. p: CSI number (p = 00, 01, 10, 20, 30, 31), m: Unit number (m = 0, 1), n: Channel number (n = 0 to 3), g: PIM and POM number (g = 0, 1, 3 to 5, 14)
- Remark 2. CSI01 of 48-, 52-, 64-pin products, and CSI11 and CSI21 cannot communicate at different potential. Use other CSI for communication at different potential.

RL78/G14

2.6.2 Temperature sensor characteristics/internal reference voltage characteristic

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Temperature sensor output voltage	VTMPS25	Setting ADS register = 80H, T _A = +25°C		1.05		V
Internal reference voltage	Vbgr	Setting ADS register = 81H	1.38	1.45	1.5	V
Temperature coefficient	FVTMPS	Temperature sensor that depends on the temperature		-3.6		mV/°C
Operation stabilization wait time	tamp		5			μs

(TA = -40 to +85°C, 2.4 V \leq VDD \leq 5.5 V, VSS = EVSS0 = EVSS1 = 0 V, HS (high-speed main) mode)

2.6.3 D/A converter characteristics

(TA = -40 to +85°C, 1.6 V \leq EVsso = EVss1 \leq VDD \leq 5.5 V, Vss = EVsso = EVss1 = 0 V)

Parameter	Symbol	Con	ditions	MIN.	TYP.	MAX.	Unit
Resolution	RES					8	bit
Overall error	AINL	Rload = 4 M Ω	$1.8~V \le V_{DD} \le 5.5~V$			±2.5	LSB
		Rload = 8 M Ω	$1.8~V \le V_{DD} \le 5.5~V$			±2.5	LSB
Settling time	t SET	Cload = 20 pF	$2.7~V \leq V_{DD} \leq 5.5~V$			3	μs
			$1.6 \text{ V} \le \text{V}_{\text{DD}}$ < 2.7 V			6	μs



3.2 Oscillator Characteristics

3.2.1 X1, XT1 characteristics

$(TA = -40 \text{ to } +105^{\circ}C, 2.4 \text{ V} \le \text{VDD} \le 5.5 \text{ V}, \text{Vss} = 0 \text{ V})$

Resonator	Resonator	Conditions	MIN.	TYP.	MAX.	Unit
X1 clock oscillation frequency (fx) Note	Ceramic resonator/	$2.7~V \leq V \text{DD} \leq 5.5~V$	1.0		20.0	MHz
	crystal resonator	$2.4 \text{ V} \leq \text{V}_{\text{DD}} \leq 2.7 \text{ V}$	1.0		16.0	
XT1 clock oscillation frequency (fxT) Note	Crystal resonator		32	32.768	35	kHz

Note Indicates only permissible oscillator frequency ranges. Refer to AC Characteristics for instruction execution time. Request evaluation by the manufacturer of the oscillator circuit mounted on a board to check the oscillator characteristics.

Caution Since the CPU is started by the high-speed on-chip oscillator clock after a reset release, check the X1 clock oscillation stabilization time using the oscillation stabilization time counter status register (OSTC) by the user. Determine the oscillation stabilization time of the OSTC register and the oscillation stabilization time select register (OSTS) after sufficiently evaluating the oscillation stabilization time with the resonator to be used.

Remark When using the X1 oscillator and XT1 oscillator, refer to 5.4 System Clock Oscillator in the RL78/G14 User's Manual.

3.2.2 On-chip oscillator characteristics

(TA = -40 to +105°C, 2.4 V \leq VDD \leq 5.5 V, Vss = 0 V)

Oscillators	Parameters	Co	onditions	MIN.	TYP.	MAX.	Unit
High-speed on-chip oscillator clock frequency Notes 1, 2	fін					32	MHz
High-speed on-chip oscillator clock frequency		-20 to +85°C	$2.4~V \leq V \text{DD} \leq 5.5~V$	-1.0		+1.0	%
accuracy		-40 to -20°C	$2.4~V \leq V \text{DD} \leq 5.5~V$	-1.5		+1.5	%
		+85 to +105°C	$2.4~V \leq V \text{DD} \leq 5.5~V$	-2.0		+2.0	%
Low-speed on-chip oscillator clock frequency	fı∟				15		kHz
Low-speed on-chip oscillator clock frequency accuracy				-15		+15	%

Note 1. High-speed on-chip oscillator frequency is selected with bits 0 to 4 of the option byte (000C2H) and bits 0 to 2 of the HOCODIV register.

Note 2. This only indicates the oscillator characteristics. Refer to AC Characteristics for instruction execution time.



3.3 DC Characteristics

3.3.1 Pin characteristics

$(Ta = -40 \text{ to } +105^{\circ}C, 2.4 \text{ V} \le EVDD0 = EVDD1 \le VDD \le 5.5 \text{ V}, \text{ Vss} = EVss0 = EVss1 = 0 \text{ V})$

Items	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Output current, high Note 1	Іон1	Per pin for P00 to P06, P10 to P17, P30, P31, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100 to P102, P110, P111, P120, P130, P140 to P147	$2.4 \text{ V} \le \text{EV}_{\text{DD0}} \le 5.5 \text{ V}$			-3.0 Note 2	mA
		Total of P00 to P04, P40 to P47, 4.0 P102, P120, P130, P140 to P145 2.7 (When duty \leq 70% Note 3) 2.4	$4.0~V \le EV_{DD0} \le 5.5~V$			-30.0	mA
			$2.7 \text{ V} \le \text{EV}_{\text{DD0}} \le 4.0 \text{ V}$			-10.0	mA
			$2.4 \text{ V} \le \text{EV}_{\text{DD0}} \le 2.7 \text{ V}$			-5.0	mA
		Total of P05, P06, P10 to P17, 4 P30, P31, P50 to P57, 7 P64 to P67, P70 to P77, 7 P80 to P87, P100, P101, P110, 7 P111, P146, P147 70% Note 3)	$4.0~V \le EV_{DD0} \le 5.5~V$			-30.0	mA
			$2.7 \text{ V} \le \text{EV}_{\text{DD0}} \le 4.0 \text{ V}$			-19.0	mA
			2.4 V ≤ EVDD0 < 2.7 V			-10.0	mA
-		Total of all pins (When duty \leq 70% ^{Note 3})	$2.4 \text{ V} \leq \text{EVDD0} \leq 5.5 \text{ V}$			-60.0	mA
	Іон2	Per pin for P20 to P27, P150 to P156	$2.4 \text{ V} \leq \text{VDD} \leq 5.5 \text{ V}$			-0.1 Note 2	mA
		Total of all pins (When duty \leq 70% ^{Note 3})	$2.4 \text{ V} \leq \text{VDD} \leq 5.5 \text{ V}$			-1.5	mA

Note 1. Value of current at which the device operation is guaranteed even if the current flows from the EVDD0, EVDD1, VDD pins to an output pin.

Note 2. Do not exceed the total current value.

Note 3. Specification under conditions where the duty factor \leq 70%.

The output current value that has changed to the duty factor > 70% the duty ratio can be calculated with the following expression (when changing the duty factor from 70% to n%).

- Total output current of pins = (IOH × 0.7)/(n × 0.01)
- <Example> Where n = 80% and IOH = -10.0 mA Total output current of pins = $(-10.0 \times 0.7)/(80 \times 0.01) \approx -8.7$ mA

However, the current that is allowed to flow into one pin does not vary depending on the duty factor. A current higher than the absolute maximum rating must not flow into one pin.

Caution P00, P02 to P04, P10, P11, P13 to P15, P17, P30, P43 to P45, P50 to P55, P71, P74, P80 to P82, and P142 to P144 do not output high level in N-ch open-drain mode.

Remark Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.



Items	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Input voltage, high	Vih1	P00 to P06, P10 to P17, P30, P31, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100 to P102, P110, P111, P120, P140 to P147	Normal input buffer	0.8 EVDD0		EVddo	V
	VIH2	P01, P03, P04, P10, P14 to P17, P30, P43, P44, P50, P53 to P55,	TTL input buffer $4.0 \text{ V} \le \text{EV}_{\text{DD0}} \le 5.5 \text{ V}$	2.2		EVDD0	V
		P80, P81, P142, P143	TTL input buffer $3.3 \text{ V} \le \text{EV}_{\text{DD0}} < 4.0 \text{ V}$	2.0		EVDD0	V
			TTL input buffer 2.4 V ≤ EVDD0 < 3.3 V	1.5		EVDD0	V
Vı Vı	Vінз	P20 to P27, P150 to P156		0.7 Vdd		Vdd	V
	VIH4	P60 to P63	0.7 EVDD0		6.0	V	
Vih5		P121 to P124, P137, EXCLK, EX	CLKS, RESET	0.8 Vdd		Vdd	V
Input voltage, low	VIL1	P00 to P06, P10 to P17, P30, P31, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100 to P102, P110, P111, P120, P140 to P147	Normal input buffer	0		0.2 EVDD0	V
	VIL2	P01, P03, P04, P10, P14 to P17, P30, P43, P44, P50, P53 to P55,	TTL input buffer $4.0 \text{ V} \le \text{EV}_{\text{DD0}} \le 5.5 \text{ V}$	0		0.8	V
		P80, P81, P142, P143	TTL input buffer $3.3 \text{ V} \le \text{EV}_{\text{DD0}} < 4.0 \text{ V}$	0		0.5	V
			TTL input buffer 2.4 V ≤ EVDD0 < 3.3 V	0		0.32	V
	VIL3	P20 to P27, P150 to P156		0		0.3 VDD	V
	VIL4	P60 to P63		0		0.3 EVDD0	V
	VIL5	P121 to P124, P137, EXCLK, EXCLKS, RESET		0		0.2 VDD	V

(TA = -40 to +105°C, 2.4 V \leq EVDD0 = EVDD1 \leq VDD \leq 5.5 V, Vss = EVss0 = EVss1 = 0 V)

(3/5)

The maximum value of VIH of pins P00, P02 to P04, P10, P11, P13 to P15, P17, P30, P43 to P45, P50 to P55, P71, P74, P80 to P82, and P142 to P144 is EVDD0, even in the N-ch open-drain mode.

Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins. Remark

Caution



(4) During communication at same potential (simplified I²C mode)

|--|

Parameter	Symbol	Conditions	HS (high-speed	HS (high-speed main) mode	
			MIN.	MAX.	
SCLr clock frequency	fscL	$\begin{array}{l} 2.7 \ \text{V} \leq EV_{\text{DD0}} \leq 5.5 \ \text{V}, \\ C_{b} = 50 \ \text{pF}, \ R_{b} = 2.7 \ \text{k}\Omega \end{array}$		400 Note 1	kHz
		$\begin{array}{l} 2.4 \ V \leq EV_{DD0} \leq 5.5 \ V, \\ C_{b} = 100 \ pF, \ R_{b} = 3 \ k\Omega \end{array}$		100 Note 1	kHz
Hold time when SCLr = "L"	t∟ow	$\begin{array}{l} 2.7 \ \text{V} \leq E V_{\text{DD0}} \leq 5.5 \ \text{V}, \\ \text{C}_{\text{b}} = 50 \ \text{pF}, \ \text{R}_{\text{b}} = 2.7 \ \text{k}\Omega \end{array}$	1200		ns
		$\begin{array}{l} 2.4 V \leq EV_{DD0} \leq 5.5 \; V, \\ C_{b} = 100 \; pF, \; R_{b} = 3 \; k\Omega \end{array}$	4600		ns
Hold time when SCLr = "H"	thigh	$\begin{array}{l} 2.7 \mbox{ V} \leq EV_{DD0} \leq 5.5 \mbox{ V}, \\ C_b = 50 \mbox{ pF}, \mbox{ R}_b = 2.7 \Omega \end{array}$	1200		ns
		$\begin{array}{l} 2.4 \ V \leq EV_{DD0} \leq 5.5 \ V, \\ C_{b} \texttt{=} 100 \ pF, \ R_{b} \texttt{=} 3 \ k\Omega \end{array}$	4600		ns
Data setup time (reception)	tsu: dat	$\begin{array}{l} 2.7 \ \text{V} \leq E V_{\text{DD0}} \leq 5.5 \ \text{V}, \\ C_b = 50 \ \text{pF}, \ \text{R}_b = 2.7 \ \text{k}\Omega \end{array}$	1/f _{MCK} + 220 Note 2		ns
		$\label{eq:linear} \begin{split} 2.4 V &\leq E V_{DD0} \leq 5.5 \; V, \\ C_{b} &= 100 \; pF, \; R_{b} = 3 \; k \Omega \end{split}$	1/f _{MCK} + 580 Note 2		ns
Data hold time (transmission)	thd: dat	$\begin{array}{l} 2.7 \ \text{V} \leq E V_{\text{DD0}} \leq 5.5 \ \text{V}, \\ \text{C}_{\text{b}} = 50 \ \text{pF}, \ \text{R}_{\text{b}} = 2.7 \ \text{k}\Omega \end{array}$	0	770	ns
		$\begin{array}{l} 2.4 \ V \leq EV_{DD0} \leq 5.5 \ V, \\ C_{b} = 100 \ pF, \ R_{b} = 3 \ k\Omega \end{array}$	0	1420	ns

Note 1. The value must also be equal to or less than fMCK/4.

Note 2. Set the fMCK value to keep the hold time of SCLr = "L" and SCLr = "H".

Caution Select the normal input buffer and the N-ch open drain output (VDD tolerance (for the 30- to 52-pin products)/EVDD tolerance (for the 64- to 100-pin products)) mode for the SDAr pin and the normal output mode for the SCLr pin by using port input mode register g (PIMg) and port output mode register h (POMh).

(**Remarks** are listed on the next page.)



3.6.2 Temperature sensor characteristics/internal reference voltage characteristic

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Temperature sensor output voltage	VTMPS25	Setting ADS register = 80H, T _A = +25°C		1.05		V
Internal reference voltage	Vbgr	Setting ADS register = 81H	1.38	1.45	1.5	V
Temperature coefficient	Fvtmps	Temperature sensor that depends on the temperature		-3.6		mV/°C
Operation stabilization wait time	tamp		5			μs

(TA = -40 to +105°C, 2.4 V \leq VDD \leq 5.5 V, Vss = EVsso = EVss1 = 0 V, HS (high-speed main) mode)

3.6.3 D/A converter characteristics

(TA = -40 to +105°C, 2.4 V \leq EVsso = EVss1 \leq VDD \leq 5.5 V, Vss = EVsso = EVss1 = 0 V)

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Resolution	RES					8	bit
Overall error	AINL	Rload = 4 M Ω	$2.4~V \leq V_{DD} \leq 5.5~V$			±2.5	LSB
		Rload = 8 M Ω	$2.4~V \leq V_{DD} \leq 5.5~V$			±2.5	LSB
Settling time	t SET	Cload = 20 pF	$2.7~V \leq V_{DD} \leq 5.5~V$			3	μs
			$2.4~V \leq V_{DD} < 2.7~V$			6	μs



4. PACKAGE DRAWINGS

4.1 30-pin products

R5F104AAASP, R5F104ACASP, R5F104ADASP, R5F104AEASP, R5F104AFASP, R5F104AGASP R5F104AADSP, R5F104ACDSP, R5F104ADDSP, R5F104AEDSP, R5F104AFDSP, R5F104AGDSP R5F104AAGSP, R5F104ACGSP, R5F104ADGSP, R5F104AEGSP, R5F104AFGSP, R5F104AGGSP

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-LSSOP30-0300-0.65	PLSP0030JB-B	S30MC-65-5A4-3	0.18







NOTE

Each lead centerline is located within 0.13 mm of its true position (T.P.) at maximum material condition.



·κ

Α 9.85±0.15 в 0.45 MAX С 0.65 (T.P.) $0.24_{-0.07}^{+0.08}$ D F 0.1±0.05 F 1.3±0.1 G 1.2 8.1±0.2 Н 6.1±0.2 I 1.0±0.2 J 0.17±0.03 κ L 0.5 0.13 Μ Ν 0.10 Р 3°+5° 0.25 т 0.6±0.15 U

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4.6 48-pin products

R5F104GAAFB, R5F104GCAFB, R5F104GDAFB, R5F104GEAFB, R5F104GFAFB, R5F104GGAFB, R5F104GHAFB, R5F104GJAFB

R5F104GADFB, R5F104GCDFB, R5F104GDDFB, R5F104GEDFB, R5F104GFDFB, R5F104GGDFB, R5F104GHDFB, R5F104GJDFB

R5F104GAGFB, R5F104GCGFB, R5F104GDGFB, R5F104GEGFB, R5F104GFGFB, R5F104GGGFB, R5F104GHGFB, R5F104GJGFB

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-LFQFP48-7x7-0.50	PLQP0048KF-A	P48GA-50-8EU-1	0.16



NOTE

Each lead centerline is located within 0.08 mm of its true position at maximum material condition.



ZE

0.75

R5F104LCAFP, R5F104LDAFP, R5F104LEAFP, R5F104LFAFP, R5F104LGAFP, R5F104LHAFP, R5F104LJAFP R5F104LCDFP, R5F104LDDFP, R5F104LEDFP, R5F104LFDFP, R5F104LGDFP, R5F104LHDFP, R5F104LJDFP R5F104LCGFP, R5F104LDGFP, R5F104LEGFP, R5F104LFGFP, R5F104LGGFP, R5F104LHGFP, R5F104LJGFP

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-LQFP64-14x14-0.80	PLQP0064GA-A	P64GC-80-GBW-1	0.7



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4.10 100-pin products

R5F104PFAFB, R5F104PGAFB, R5F104PHAFB, R5F104PJAFB R5F104PFDFB, R5F104PGDFB, R5F104PHDFB, R5F104PJDFB R5F104PFGFB, R5F104PGGFB, R5F104PHGFB, R5F104PJGFB

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-LFQFP100-14x14-0.50	PLQP0100KE-A	P100GC-50-GBR-1	0.69



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